## SiHP30N60E

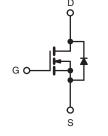
**Vishay Siliconix** 



## **E Series Power MOSFET**

PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650			
R <sub>DS(on)</sub> max. at 25 °C (Ω)	V <sub>GS</sub> = 10 V 0.125			
Q <sub>g</sub> max. (nC)	130			
Q <sub>gs</sub> (nC)	15			
Q <sub>gd</sub> (nC)	39			
Configuration	Single			





N-Channel MOSFET

### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (C<sub>iss</sub>)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>g</sub>)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
  - LED lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
- Battery chargers
- Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	SiHP30N60E-E3			
Lead (Pb)-free and Halogen-free	SiHP30N60E-GE3			

ABSOLUTE MAXIMUM RATINGS (T $_{C}$ :	= 25 °C, unless otherwis	se noted)		
PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-Source Voltage	V <sub>DS</sub>	600		
Gate-Source Voltage	N/	± 20	V	
Gate-Source Voltage AC (f > 1 Hz)	V <sub>GS</sub>	30		
Continuous Drain Current (T. 150 °C)	$V_{GS}$ at 10 V $T_C = 25 \degree C$	- I <sub>D</sub>	29	А
Continuous Drain Current ( $T_J = 150 \ ^\circ$ C)	$T_{\rm C} = 100 ^{\circ}{\rm C}$		18	
Pulsed Drain Current <sup>a</sup>	I <sub>DM</sub>	65	1	
Linear Derating Factor		2	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>	E <sub>AS</sub>	690	mJ	
Maximum Power Dissipation	PD	250	W	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-Source Voltage Slope $V_{DS} = 0 V \text{ to } 80 \% V_{DS}$		dV/dt	70	
Reverse Diode dV/dt <sup>d</sup>	18		V/ns	
Soldering Recommendations (Peak Temperature) c for 10 s			300	°C

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b.  $V_{DD}$  = 50 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>q</sub> = 25  $\Omega$ , I<sub>AS</sub> = 7 A.

c. 1.6 mm from case.

d.  $I_{SD} \leq I_D,\,dI/dt$  = 100 A/µs, starting  $T_J$  = 25 °C.

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COMPLIANT HALOGEN

FREE



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PARAMETER	SYMBOL	TYP.	MAX	MAX.		UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62	62 0.5		°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	0.5				
		•	•				
SPECIFICATIONS (T <sub>J</sub> = 25 °C, u	nless otherwi	ise noted)					
PARAMETER	SYMBOL	1	CONDITIONS	MIN.	TYP.	MAX.	UNI
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 250 μA	600	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$		to 25 °C, I <sub>D</sub> = 250 μA	-	0.64	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>		· V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	2.8	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>		$V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
<b>.</b>	000		= 600 V, V <sub>GS</sub> = 0 V	-	-	1	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>		$V_{\rm H} = 0  \text{V},  \text{T}_{\rm J} = 150  ^{\circ}\text{C}$	-	-	100	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	$I_{\rm D} = 15 \rm{A}$	-	0.104	0.125	Ω
Forward Transconductance <sup>a</sup>	9fs		$_{S} = 8 \text{ V}, \text{ I}_{D} = 3 \text{ A}$	-	5.4	-	S
Dynamic	0.0		<u> </u>			1	1
Input Capacitance	C <sub>iss</sub>		-	2600	-	pF	
Output Capacitance	C <sub>oss</sub>		V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 100 V,		138		-
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0 MHz		-	3		-
Effective Output Capacitance, Energy Related <sup>b</sup>	C <sub>o(er)</sub>	$V_{DS} = 0 V$ to 480 V, $V_{GS} = 0 V$		-	98		-
Effective Output Capacitance, Time Related <sup>c</sup>	C <sub>o(tr)</sub>			-	346		-
Total Gate Charge	Qg			-	85	130	
Gate-Source Charge	Q <sub>gs</sub>	$V_{GS} = 10 \text{ V}$	V <sub>GS</sub> = 10 V I <sub>D</sub> = 15 A, V <sub>DS</sub> = 480 V		15	-	nC
Gate-Drain Charge	Q <sub>gd</sub>			-	39	-	1
Turn-On Delay Time	t <sub>d(on)</sub>				19	40	
Rise Time	t <sub>r</sub>	V <sub>DD</sub> =	= 380 V, I <sub>D</sub> = 15 A,	-	32	65	]
Turn-Off Delay Time	t <sub>d(off)</sub>		$V_{\rm BD} = 360$ V, $T_{\rm D} = 13$ X, $V_{\rm GS} = 10$ V, $R_{\rm q} = 4.7$ $\Omega$		63	95	- ns
Fall Time	t <sub>f</sub>	ş		-	36	75	
Gate Input Resistance	Rg	f = 1	MHz, open drain	-	0.63	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	IS	MOSFET symbol showing the integral reverse p - n junction diode		-	-	29	
Pulsed Diode Forward Current	I <sub>SM</sub>			-	-	65	A
Diode Forward Voltage	V <sub>SD</sub>	$T_{\rm J}$ = 25 °C, $I_{\rm S}$ = 15 A, $V_{\rm GS}$ = 0 V		-	-	1.3	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 15 \text{ A},$ $dI/dt = 100 \text{ A/}\mu\text{s}, V_{R} = 20 \text{ V}$		-	402	605	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	7	15	μC
Reverse Recovery Current	I <sub>RRM</sub>			_	32	65	A

### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .

c.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .



## SiHP30N60E

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

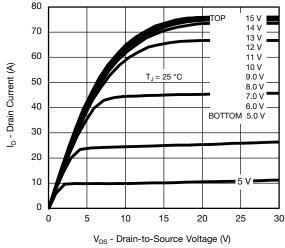
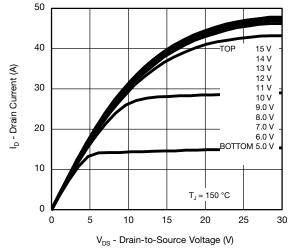
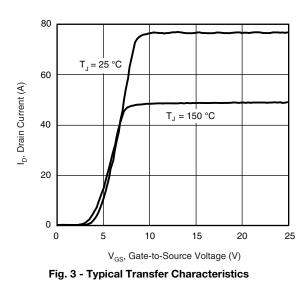


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C







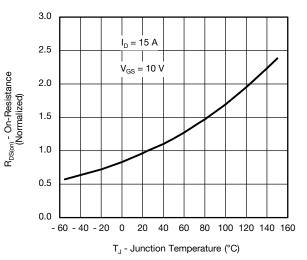


Fig. 4 - Normalized On-Resistance vs. Temperature

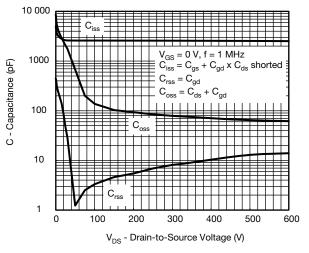
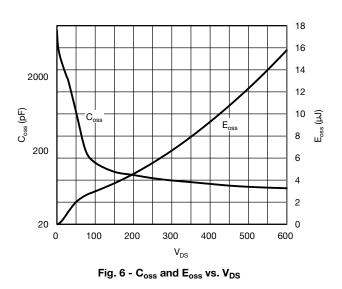


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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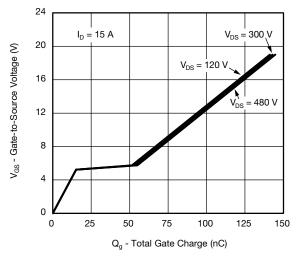


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

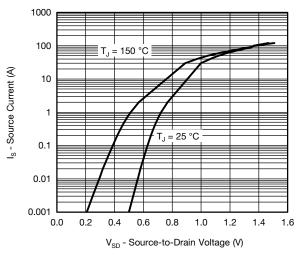


Fig. 8 - Typical Source-Drain Diode Forward Voltage

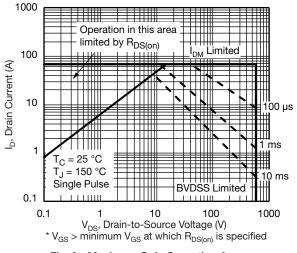


Fig. 9 - Maximum Safe Operating Area

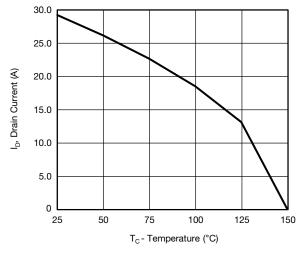


Fig. 10 - Maximum Drain Current vs. Case Temperature

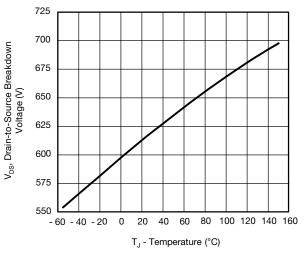
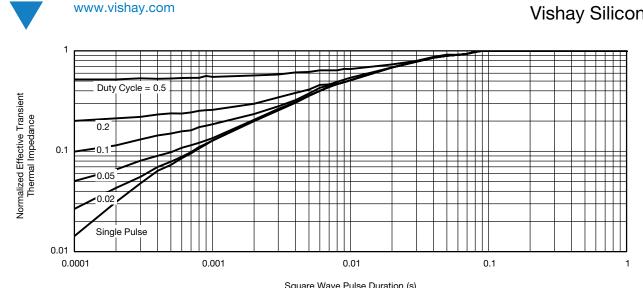


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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Square Wave Pulse Duration (s) Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

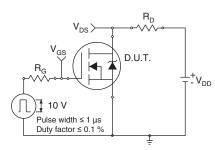


Fig. 13 - Switching Time Test Circuit

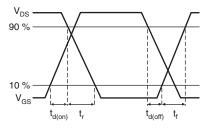


Fig. 14 - Switching Time Waveforms

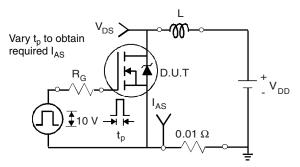


Fig. 15 - Unclamped Inductive Test Circuit

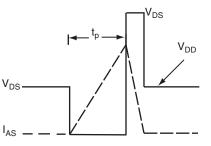


Fig. 16 - Unclamped Inductive Waveforms

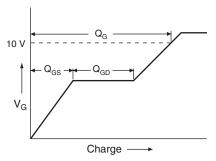


Fig. 17 - Basic Gate Charge Waveform

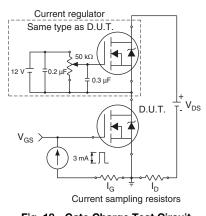


Fig. 18 - Gate Charge Test Circuit

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### Peak Diode Recovery dV/dt Test Circuit

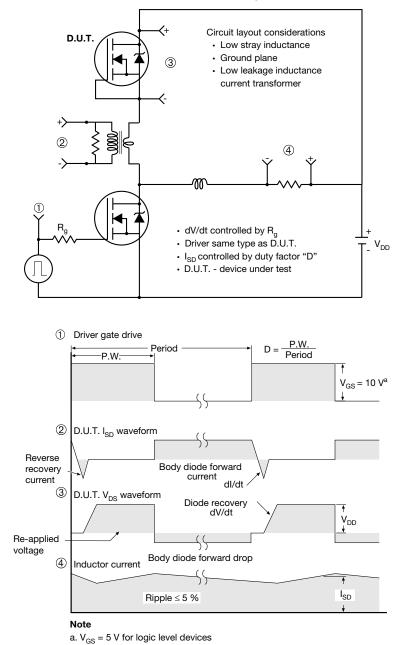


Fig. 19 - For N-Channel

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## **TO-220AB**



	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.25	4.65	0.167	0.183
b	0.69	1.01	0.027	0.040
b(1)	1.20	1.73	0.047	0.068
С	0.36	0.61	0.014	0.024
D	14.85	15.49	0.585	0.610
D2	12.19	12.70	0.480	0.500
E	10.04	10.51	0.395	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.09	6.48	0.240	0.255
J(1)	2.41	2.92	0.095	0.115
L	13.35	14.02	0.526	0.552
L(1)	3.32	3.82	0.131	0.150
ØР	3.54	3.94	0.139	0.155
Q	2.60	3.00	0.102	0.118
	0413-Rev. P,		0.102	0.118

Note

 $^{\star}$  M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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